

HVM189S

Silicon Epitaxial Planar Pin Diode for High Frequency Attenuator

REJ03G0442-0100
(Previous: ADE-208-1502)
Rev.1.00
Dec 20, 2004

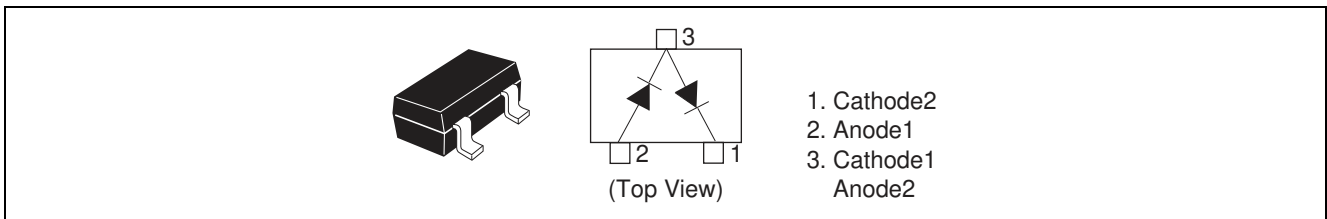
Features

- Low forward resistance. ($r_f = 5.5 \Omega$ max)
- MPAK package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HVM189S	H9	MPAK

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	60	V
Forward current	I_F	50	mA
Power dissipation	P_d *1	100	mW
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to +125	°C

Note: 1. Per one device.

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I_R	—	—	100	nA	$V_R = 60$ V
Forward voltage	V_F	—	—	1.0	V	$I_F = 10$ mA
Capacitance	C	—	—	2.4	pF	$V_R = 0$ V, $f = 1$ MHz
Forward resistance	r_f	3.5	—	5.5	Ω	$I_F = 10$ mA, $f = 100$ MHz
ESD-Capability *1	—	200	—	—	V	C = 200 pF, R = 0 Ω , Both forward and reverse direction 1 pulse.

Note: 1. Failure criterion; $I_R > 100$ nA at $V_R = 60$ V

Main Characteristic

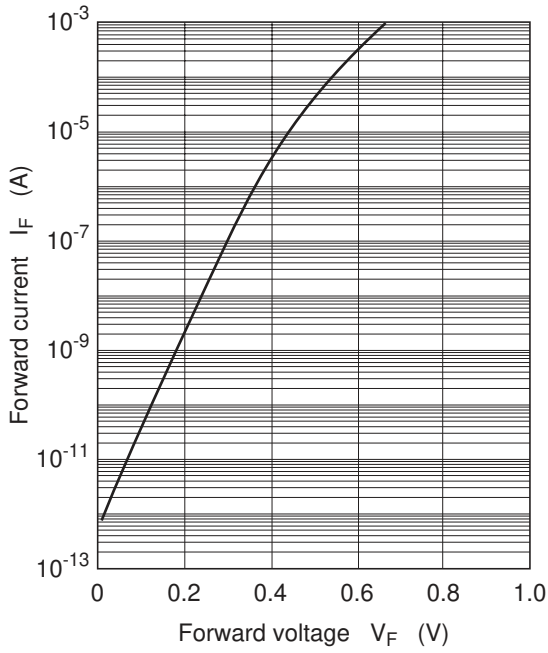


Fig.1 Forward current vs. Forward voltage

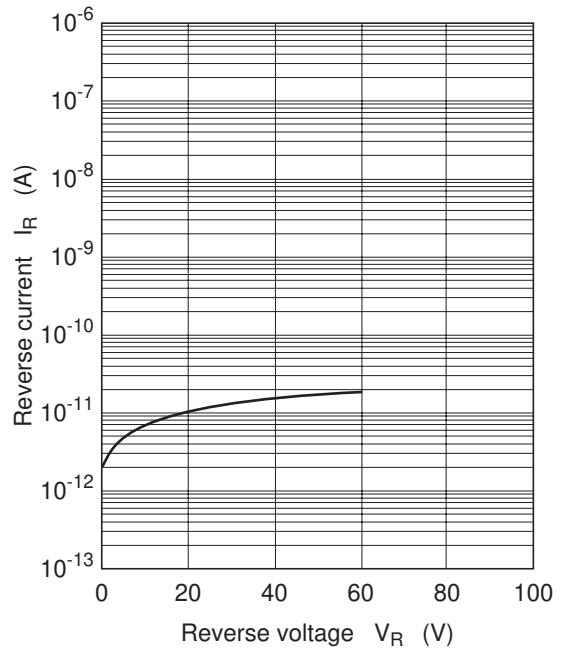


Fig.2 Reverse current vs. Reverse voltage

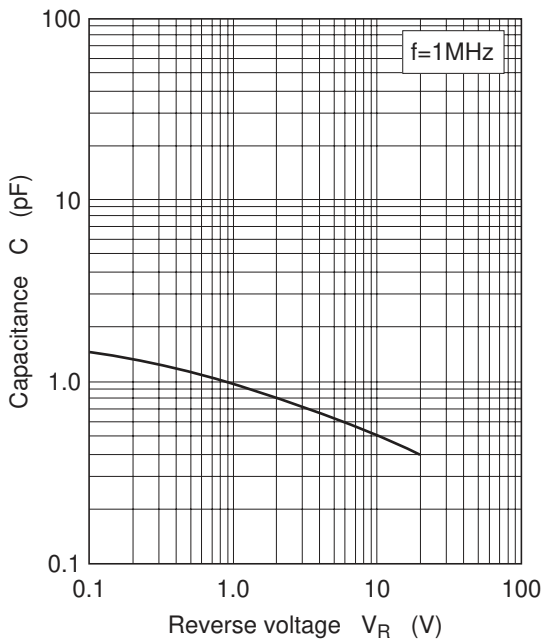


Fig.3 Capacitance vs. Reverse voltage

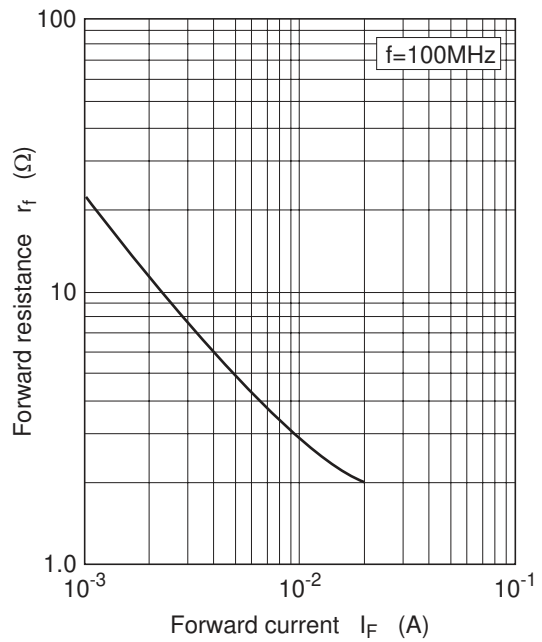
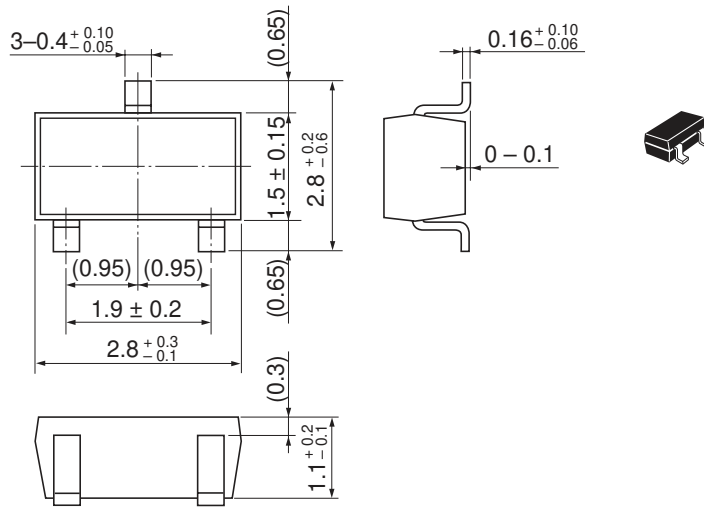


Fig.4 Forward resistance vs. Forward current

Package Dimensions

As of January, 2003
Unit: mm



Package Code	MPAK
JEDEC	—
JEITA	Conforms
Mass (reference value)	0.011 g

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April 1st, 2010
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